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ABSTRACT

A trench MOSFET (Metal Oxide Semiconductor Field Effect Transistor) structure includes criss-crossing trenches formed in a semiconductor substrate. The trenches include inner surfaces filled with conductive material which is electrically separated from the substrate by insulating The conductive material is in contact with an material. overlying first metal layer through a plurality of first contact openings formed in a first insulating layer which is sandwiched between the first metal layer and the trenches. The conductive material in the trenches and the first metal layer constitute the gate of the MOSFET structure. also a second metal layer in contact with a source layer formed in the substrate through a plurality of second 15 contact openings formed in a second insulating layer which is sandwiched between the first metal layer and the second The second metal layer and the source layer metal layer. constitute the source of the MOSFET structure. As arranged, the gate and source of the MOSFET structure are connected through separate metal layers on the semiconductive substrate. As a consequence, each metal layer maintains a higher conductivity and thus faster frequency response. semiconductor structure formed in accordance with the invention can also assume a higher packing density with lower power-on resistance.